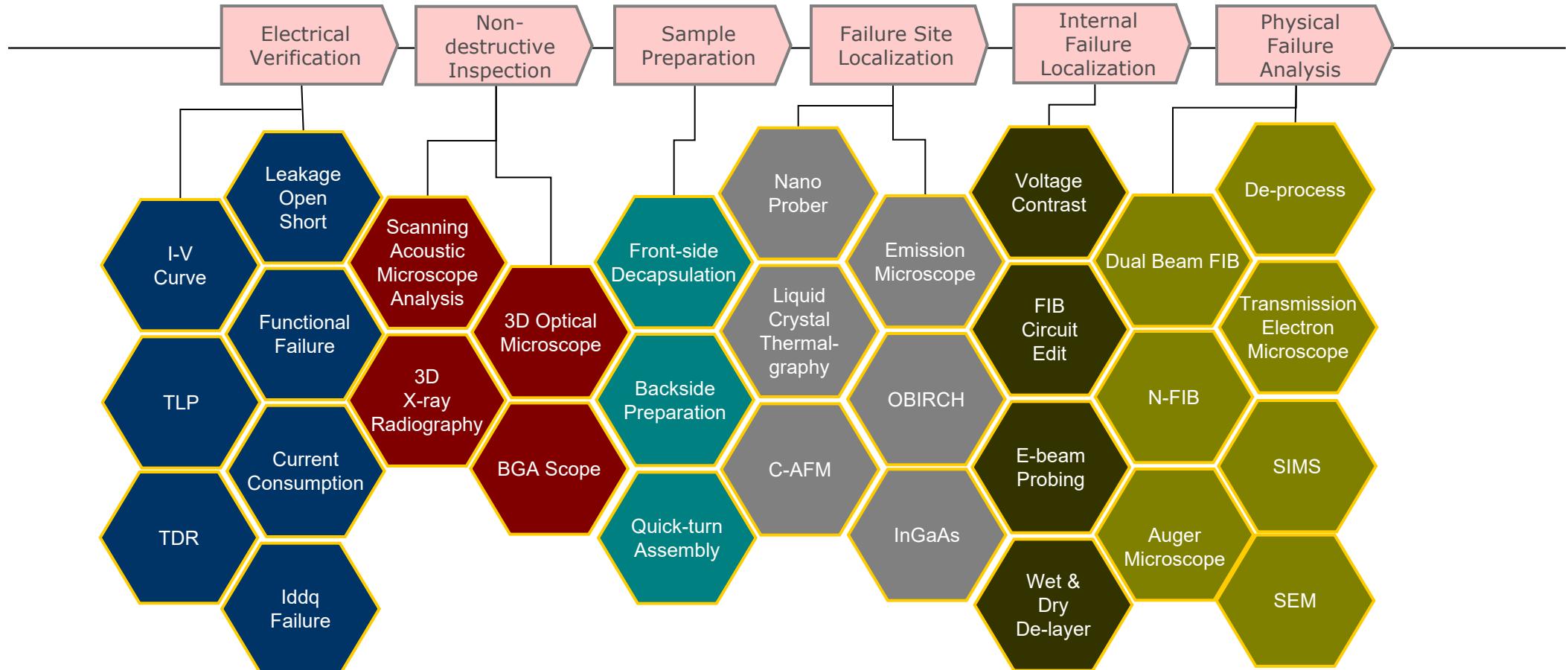


半导体事业部(SEMI,AP,FA,RA)

# 专业销售专业FA失效分析设备-依性能



**ThermoFisher**  
SCIENTIFIC

**SONIX<sup>®</sup>**

**Leica**  
MICROSYSTEMS



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INDUSTRIES

Seeing beyond

物理气相沉积 (PVD)	电化学沉积 (ECD)* (晶圆/面板级电镀)	激光切割*	晶圆/面板级扇出*	超精密固晶* (硅光子学)	巨量转移及群焊 (先进显示屏)	多芯片模组 焊接	热压式焊接*	混合式焊接*	倒装芯片焊 接	晶圆级扇入	SMT 系统级封装 (SIP) 印刷	SMT 系统级封装 (SIP) 贴片*				
APOLLO	STRATUS	LASER1205	NUCLEUS	SIPLACE CA	NANO	NOVA	Photon Pro	VORTEX II	AD300 PRO	VECTOR	FIREBIRD	LITHOBOLT	AD8312FC	SUNBIRD	DEK Galaxy	SIPLACE TX micron

# 提供专业可靠度设备 *Product Reliability Test*

- Environment Test Items:
  - PRE  
Preconditioning
  - THB  
Temperature Humidity Bias Test
  - HAST  
Highly Accelerated Stress Test
  - PCT  
Pressure Cooker Test
  - TCT  
Temperature Cycling Test
  - TST  
Thermal Shock Test
  - HTSL  
High Temperature Storage Life



# 销售客户

